



DMN2022UFDF

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	l _D max T _A = +25°C
	22mΩ @ V _{GS} = 4.5V	7.9A
001/	26mΩ @ V _{GS} = 2.5V	7.2A
20V	36mΩ @ V _{GS} = 1.8V	6.1A
	50mΩ @ V _{GS} = 1.5V	5.2A

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Battery Management Application
- Power Management Functions
- DC-DC Converters

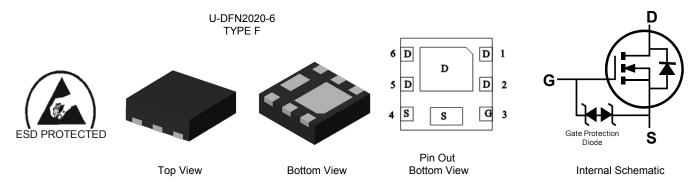
20V N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- 0.6mm profile ideal for low profile applications
- PCB footprint of 4mm²
- Low Gate Threshold Voltage
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-DFN2020-6 TYPE F
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.0065 grams (approximate)



Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Quantity per reel
DMN2022UFDF-7	NC	7	3,000
DMN2022UFDF-13	NC	13	10,000

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"

and Lead-free.

3. Halogen and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>

For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



NC = Product Type Marking Code

- YM = Date Code Marking
- Y = Year (ex: A = 2013)
- M = Month (ex: 9 = September)

Date Code Key

Notes:

Date Coue Key												
Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Y		Z		А	E	3	С		D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	20	V		
Gate-Source Voltage		V _{GSS}	±8	V	
	Steady State	T _A = +25°C T _A = +70°C	ID	7.9 6.3	A
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<5s	T _A = +25°C T _A = +70°C	I _D	9.4 7.5	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)		I _{DM}	40	A	
Continuous Source-Drain Diode Current	T _A = +25°C	IS	2	А	
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	12	A		
Avalanche Energy (Note 7) L = 0.1mH	E _{AS}	8	mJ		

Thermal Characteristics

Characteristic		Symbol	Value	Units	
Total Dawar Dissinction (Nata 5)	T _A = +25°C	D	0.66	W	
Total Power Dissipation (Note 5)	T _A = +70°C	PD	0.42		
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	P	188	°C/W	
Thermal Resistance, sunction to Ambient (Note 5)	t<5s	$R_{\theta JA}$	135		
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.03	W	
Total Fower Dissipation (Note 0)	T _A = +70°C	FD	1.31	vv	
Thermal Desistance, Junction to Ambient (Note 6)	Steady state	P	60	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<5s	R _{0JA}	43		
Thermal Resistance, Junction to Case (Note 6)	Steady state	R _{θJC}	8.3		
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

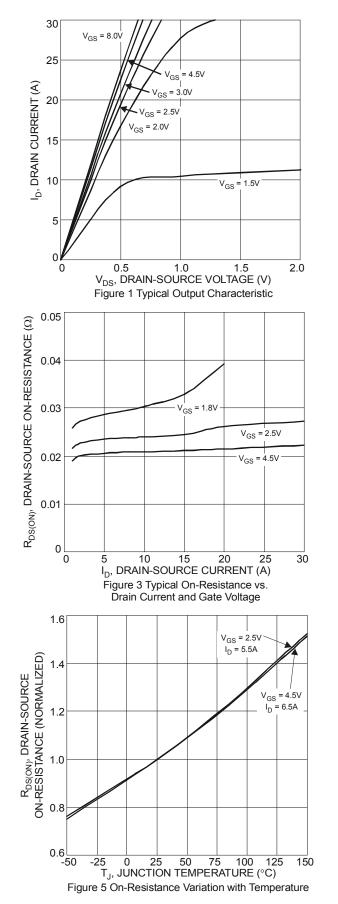
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

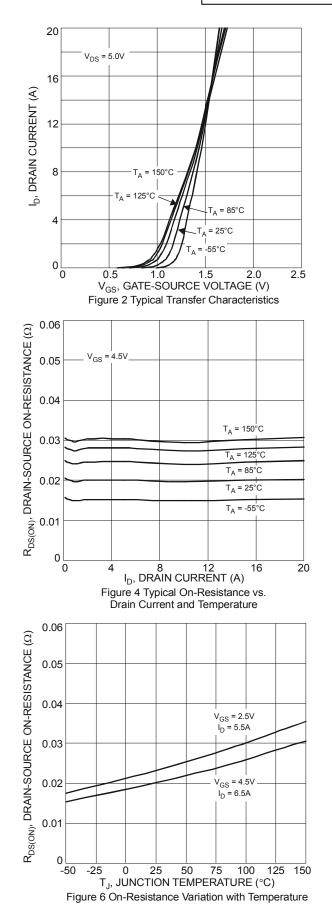
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	· ·					-	
Drain-Source Breakdown Voltage	BV _{DSS}	20	—	-	V	V _{GS} = 0V, I _D = 250µA	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	—	—	1	μA	V _{DS} = 20V, V _{GS} = 0V	
Gate-Source Leakage	Igss	—	—	±10	μA	V_{GS} = ±8V, V_{DS} = 0V	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(th)}	0.5	—	1.0	V	V_{DS} = V_{GS} , I_D = 250 μ A	
			15	22		V _{GS} = 4.5V, I _D = 4A	
Static Drain-Source On-Resistance	Decision		18	26	mΩ	V _{GS} = 2.5V, I _D = 4A	
Static Drain-Source On-Resistance	R _{DS (ON)}	_	24	36	11175	V _{GS} = 1.8V, I _D = 4A	
			35	50		V _{GS} = 1.5V, I _D = 4A	
Forward Transfer Admittance	Y _{fs}	—	18	_	S	V _{DS} = 5V, I _D = 12A	
Diode Forward Voltage	V _{SD}	_	0.7	1.0	V	V _{GS} = 0V, I _S = 5A	
DYNAMIC CHARACTERISTICS (Note 9)	• •					-	
Input Capacitance	Ciss	—	907	-			
Output Capacitance	Coss	—	98	—	pF	V _{DS} = 10V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	—	38	-		1 - 1.00012	
Gate Resistance	Rg	—	194	—	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz	
Total Gate Charge (V _{GS} = 4.5V)	Qg	—	9.8	—			
Total Gate Charge (V _{GS} = 8V)	Qg	—	18	-	nC	V _{DS} = 10V, I _D = 6.5A	
Gate-Source Charge	Q _{gs}	—	1.5	—	nc	$v_{\rm DS} = 10v, I_{\rm D} = 0.5A$	
Gate-Drain Charge	Q _{gd}	—	1.8	—			
Turn-On Delay Time	t _{D(on)}	—	56	—			
Turn-On Rise Time	tr	_	87	—		$V_{DS} = 10V, V_{GS} = 4.5V,$	
Turn-Off Delay Time	t _{D(off)}	_	632	—	ns	$R_G = 6\Omega, R_L = 10\Omega, I_D = 1A$	
Turn-Off Fall Time	t _f	—	239	—	1		
Reverse Recovery Time	trr	_	143	—	ns	I _F = 4A, di/dt = 100A/µs	
Reverse Recovery Charge	Q _{rr}		136	_	nC	$I_{\rm F}$ = 4A, di/dt = 100A/µs	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C
8. Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to product testing. Notes:



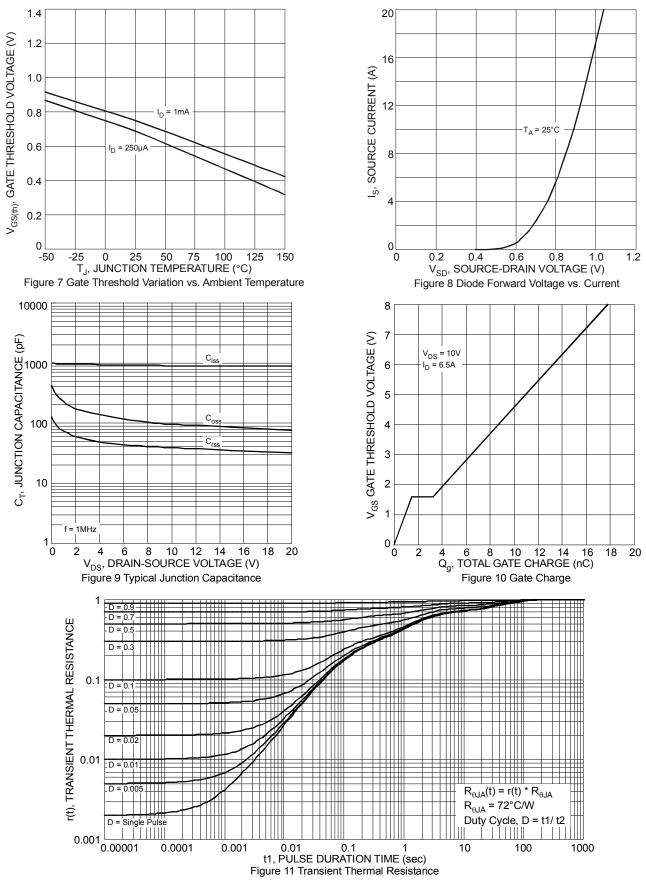
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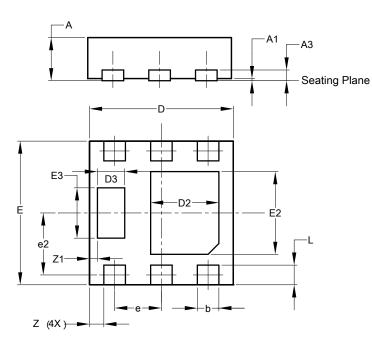
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Package Outline Dimensions

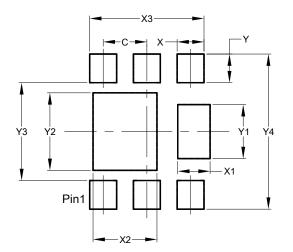
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	U-DFN2020-6								
Dim	Min	Max	Тур						
Α	0.57	0.63	0.60						
A1	0	0.05	0.03						
A3	-	-	0.15						
b	0.25	0.35	0.30						
D	1.95	2.05	2.00						
D2	0.85	1.05	0.95						
D3	0.33	0.43	0.38						
е	0.65 BSC								
e2	C).863 B	SC						
Е	1.95	2.05	2.00						
E2	1.05	1.25	1.15						
E3	0.65	0.75	0.70						
L	0.225 0.325 0.275								
Z	0.20 BSC								
Z1	0.110 BSC								
All	All Dimensions in mm								

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.650
Х	0.400
X1	0.480
X2	0.950
X3	1.700
Y	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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